



# 14.40-15.35 GHz 2-Watt Internally-Matched Power FET

Issued Date: 01-21-04

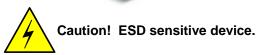
### **FEATURES**

- 14.40-15.35 GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +33.5 dBm Output Power at 1dB Compression
- 6.0 dB Power Gain at 1dB Compression
- 25% Power Added Efficiency
- -42 dBc IM3 at Po = 22.5 dBm SCL
- Hermetic Metal Flange Package
- 100% Tested for DC, RF, and R<sub>TH</sub>



The EIC1415-2 is a high power, highly linear, single stage MFET amplifier in a flange mount package. This amplifier features Excelics' unique PHEMT transistor technology.





## **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

SYMBOL	PARAMETERS/TEST CONDITIONS <sup>1</sup>	MIN	TYP	MAX	UNITS
P <sub>1dB</sub>	Output Power at 1dB Compression f = 14.40-15.35GHz $V_{DS}$ = 10 V, $I_{DSQ}$ = 550mA	32.5	33.5		dBm
G <sub>1dB</sub>	Gain at 1dB Compression $f = 14.40-15.35GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} = 550Ma$	5.0	6.0		dB
ΔG	Gain Flatness $f = 14.40-15.35GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} = 550\text{mA}$			±0.6	dB
PAE	Power Added Efficiency at 1dB Compression V <sub>DS</sub> = 10 V, I <sub>DSQ</sub> = 550mA f = 14.40-15.35GHz		25		%
ld₁ <sub>dB</sub>	Drain Current at 1dB Compression f = 14.40-15.35GHz		600	700	mA
IM3	Output 3rd Order Intermodulation Distortion $\Delta f$ = 10 MHz 2-Tone Test; Pout = 22.5 dBm S.C.L <sup>2</sup> $V_{DS}$ = 10 V, $I_{DSQ}$ ≈ 65% IDSS $f$ = 15.35GHz		-42		dBc
I <sub>DSS</sub>	Saturated Drain Current $V_{DS} = 3 \text{ V}, V_{GS} = 0 \text{ V}$		1040	1440	mA
$V_P$	Pinch-off Voltage $V_{DS} = 3 \text{ V}, I_{DS} = 10 \text{ mA}$		-2.5	-4.0	V
R <sub>TH</sub>	Thermal Resistance <sup>3</sup>		11	12	°C/W

#### Notes:

- 1. Tested with 100 Ohm gate resistor.
- 2. S.C.L. = Single Carrier Level.
- 3. Overall Rth depends on case mounting.





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# ABSOLUTE MAXIMUM RATINGS FOR CONTINUOUS OPERATION<sup>1,2</sup>

SYMBOL	CHARACTERISTIC	VALUE		
$V_{DS}$	Drain to Source Voltage	10 V		
$V_{GS}$	Gate to Source Voltage	-4.5 V		
I <sub>DS</sub>	Drain Current	IDSS		
I <sub>GSF</sub>	Forward Gate Current	20 mA		
$P_{IN}$	Input Power	@ 3dB compression		
$P_T$	Total Power Dissipation	10 W		
T <sub>CH</sub>	Channel Temperature	150°C		
$T_{STG}$	Storage Temperature	-65/+150°C		

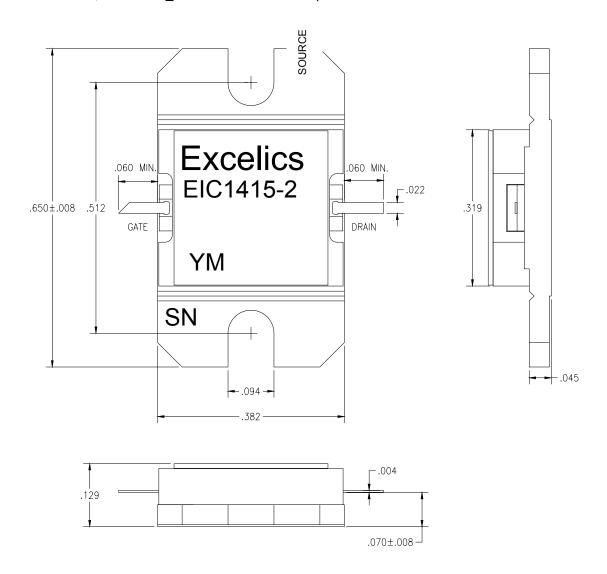
#### Notes:

- Operating the device beyond any of the above ratings may result in permanent damage or reduction of MTTF. Bias conditions must also satisfy the following equation  $P_T < (T_{CH} T_{PKG})/R_{TH}$ ; where  $T_{PKG}$  = temperature of package, and  $P_T = (V_{DS} * I_{DS}) - (P_{OUT} - P_{IN}).$



### **PACKAGE OUTLINE**

Dimensions in inches, Tolerance ± .005 unless otherwise specified



### ORDERING INFORMATION

Ì	Part Number	Grade <sup>1</sup>	f <sub>Test</sub> (GHz)	P <sub>1dB</sub> (min)	IM <sub>3</sub> (min) <sup>2</sup>
	EIC1415-2	Industrial	14.40-15.35 GHz	32.5	-38.0

Notes:

- Contact factory for military and hi-rel grades.
   Exact test conditions are specified in "Electrical Characteristics" table.